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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

|                            |   |
|----------------------------|---|
| Product Status             | Active  |
| Core Processor             | MIPS32® M4K™  |
| Core Size                  | 32-Bit Single-Core  |
| Speed                      | 80MHz   |
| Connectivity               | I <sup>2</sup> C, IrDA, LINbus, PMP, SPI, UART/USART  |
| Peripherals                | Brown-out Detect/Reset, DMA, POR, PWM, WDT  |
| Number of I/O              | 53  |
| Program Memory Size        | 128KB (128K x 8)  |
| Program Memory Type        | FLASH   |
| EEPROM Size                | -   |
| RAM Size                   | 32K x 8   |
| Voltage - Supply (Vcc/Vdd) | 2.3V ~ 3.6V   |
| Data Converters            | A/D 16x10b  |
| Oscillator Type            | Internal  |
| Operating Temperature      | -40°C ~ 85°C (TA)   |
| Mounting Type              | Surface Mount   |
| Package / Case             | 64-TQFP   |
| Supplier Device Package    | 64-TQFP (10x10)   |
| Purchase URL               | <a href="https://www.e-xfl.com/product-detail/microchip-technology/pic32mx340f128ht-80i-pt">https://www.e-xfl.com/product-detail/microchip-technology/pic32mx340f128ht-80i-pt</a> |

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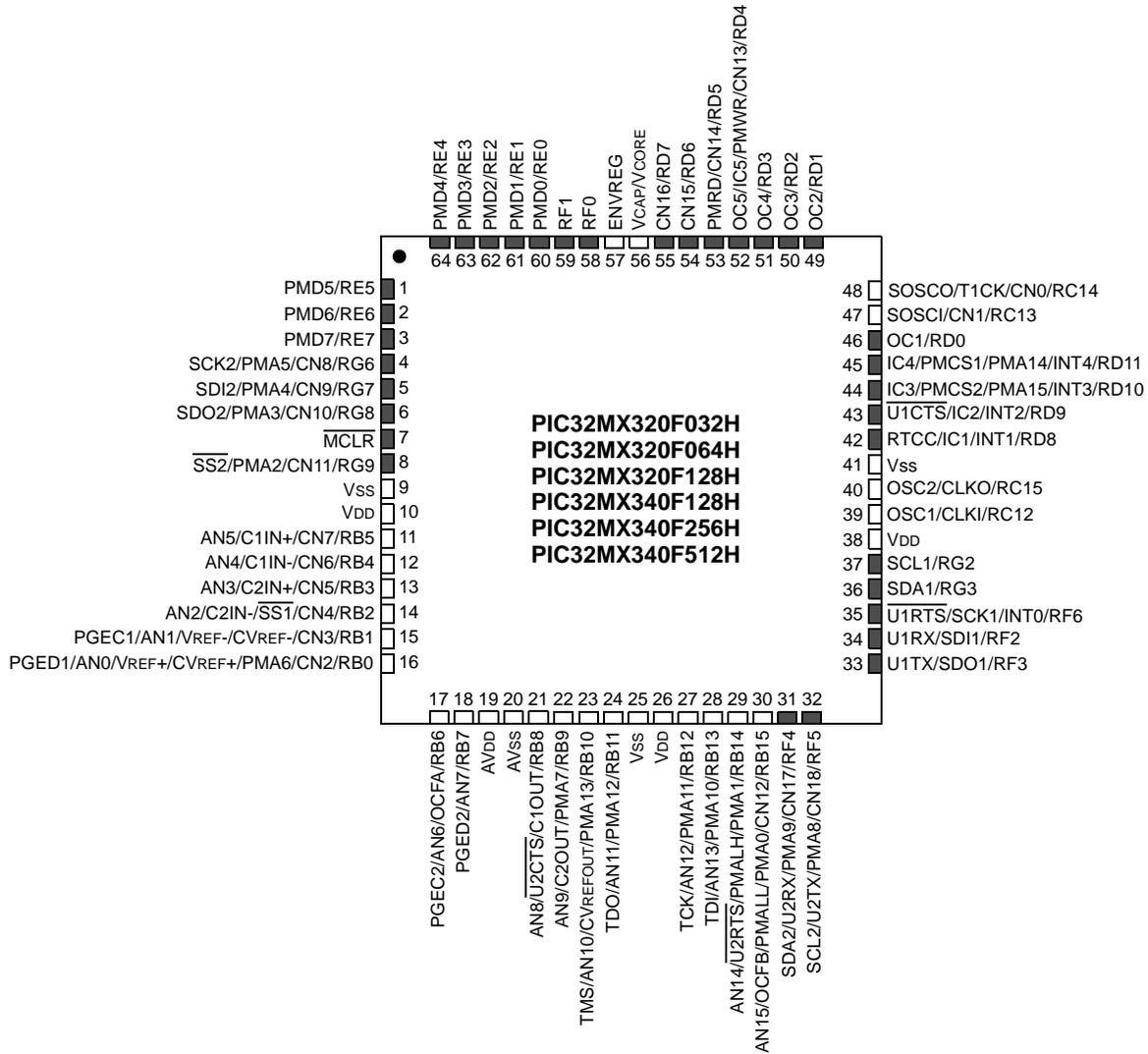
**QUALITY MANAGEMENT SYSTEM  
CERTIFIED BY DNV  
== ISO/TS 16949:2002 ==**

# PIC32MX3XX/4XX

## Pin Diagrams

64-Pin QFN (General Purpose)

■ = Pins are up to 5V tolerant

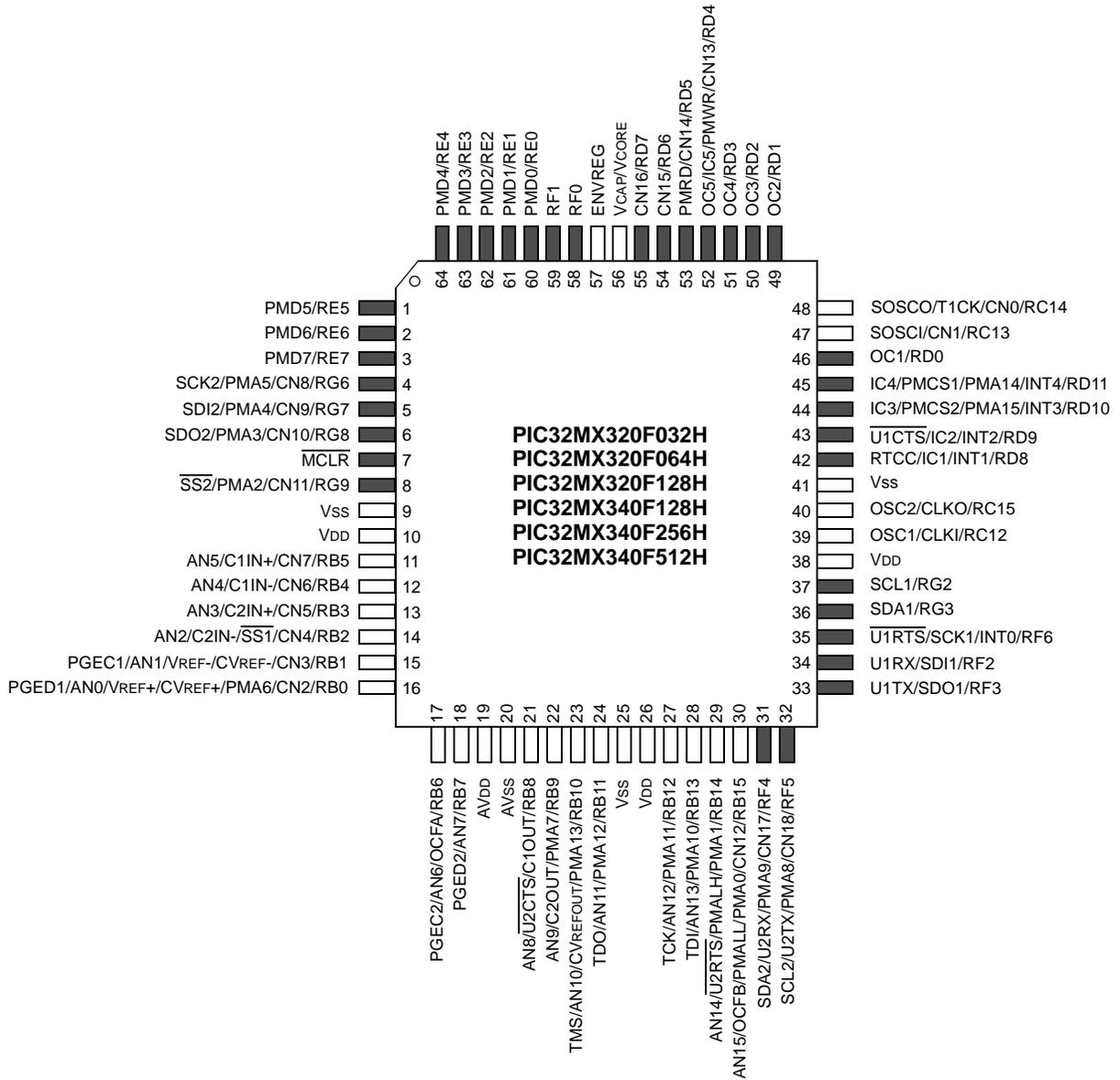


**Note:** The metal plane at the bottom of the device is not connected to any pins and is recommended to be connected to VSS externally.

## Pin Diagrams (Continued)

### 64-Pin TQFP (General Purpose)

■ = Pins are up to 5V tolerant



## Pin Diagrams (Continued)

121-Pin XBGA<sup>(1)</sup>

● = Pins are up to 5V tolerant

PIC32MX320F128L  
 PIC32MX340F128L  
 PIC32MX360F256L  
 PIC32MX360F512L

|          | 1      | 2                 | 3      | 4                  | 5                 | 6                 | 7   | 8                 | 9                 | 10     | 11     |
|----------|--------|-------------------|--------|--------------------|-------------------|-------------------|---|-------------------|-------------------|--------|--------|
| <b>A</b> | ● RE4  | ● RE3             | ● RG13 | ● RE0              | ● RG0             | ● RF1             | ○ ENVREG                                  | ○ Vss             | ● RD12            | ● RD2  | ● RD1  |
| <b>B</b> | ● NC   | ● RG15            | ● RE2  | ● RE1              | ● RA7             | ● RF0             | ○ V <sub>CORE</sub> /<br>V <sub>CAP</sub> | ● RD5             | ● RD3             | ○ Vss  | ○ RC14 |
| <b>C</b> | ● RE6  | ○ V <sub>DD</sub> | ● RG12 | ● RG14             | ● RA6             | ● NC              | ● RD7                                     | ● RD4             | ○ V <sub>DD</sub> | ○ RC13 | ● RD11 |
| <b>D</b> | ● RC1  | ● RE7             | ● RE5  | ○ Vss              | ○ Vss             | ● NC              | ● RD6                                     | ● RD13            | ● RD0             | ● NC   | ● RD10 |
| <b>E</b> | ● RC4  | ● RC3             | ● RG6  | ● RC2              | ○ V <sub>DD</sub> | ● RG1             | ○ Vss                                     | ● RA15            | ● RD8             | ● RD9  | ● RA14 |
| <b>F</b> | ● MCLR | ● RG8             | ● RG9  | ● RG7              | ○ Vss             | ● NC              | ● NC                                      | ○ V <sub>DD</sub> | ○ RC12            | ○ Vss  | ○ RC15 |
| <b>G</b> | ● RE8  | ● RE9             | ● RA0  | ● NC               | ○ V <sub>DD</sub> | ○ Vss             | ○ Vss                                     | ● NC              | ● RA5             | ● RA3  | ● RA4  |
| <b>H</b> | ○ RB5  | ○ RB4             | ○ Vss  | ○ V <sub>DD</sub>  | ● NC              | ○ V <sub>DD</sub> | ● NC                                      | ● RF7             | ● RF6             | ● RG2  | ● RA2  |
| <b>J</b> | ○ RB3  | ○ RB2             | ○ RB7  | ○ AV <sub>DD</sub> | ○ RB11            | ○ RA1             | ○ RB12                                    | ● NC              | ● NC              | ● RF8  | ○ RG3  |
| <b>K</b> | ○ RB1  | ○ RB0             | ○ RA10 | ○ RB8              | ● NC              | ● RF12            | ○ RB14                                    | ○ V <sub>DD</sub> | ● RD15            | ● RF3  | ● RF2  |
| <b>L</b> | ○ RB6  | ○ RA9             | ○ AVss | ○ RB9              | ○ RB10            | ● RF13            | ○ RB13                                    | ○ RB15            | ● RD14            | ● RF4  | ● RF5  |

**Note 1:** Refer to [Table 3](#) for full pin names.

# PIC32MX3XX/4XX

**TABLE 4: PIN NAMES: PIC32MX440F128L, PIC32MX460F256L AND PIC32MX460F512L DEVICES**

| Pin Number | Full Pin Name             |
|------------|---------------------------|
| A1         | PMD4/RE4                  |
| A2         | PMD3/RE3                  |
| A3         | TRD0/RG13                 |
| A4         | PMD0/RE0                  |
| A5         | PMD8/RG0                  |
| A6         | PMD10/RF1                 |
| A7         | ENVREG                    |
| A8         | Vss                       |
| A9         | IC5/PMD12/RD12            |
| A10        | OC3/RD2                   |
| A11        | OC2/RD1                   |
| B1         | No Connect (NC)           |
| B2         | RG15                      |
| B3         | PMD2/RE2                  |
| B4         | PMD1/RE1                  |
| B5         | TRD3/RA7                  |
| B6         | PMD11/RF0                 |
| B7         | VCAP/VCORE                |
| B8         | PMRD/CN14/RD5             |
| B9         | OC4/RD3                   |
| B10        | Vss                       |
| B11        | SOSCO/T1CK/CN0/RC14       |
| C1         | PMD6/RE6                  |
| C2         | VDD                       |
| C3         | TRD1/RG12                 |
| C4         | TRD2/RG14                 |
| C5         | TRCLK/RA6                 |
| C6         | No Connect (NC)           |
| C7         | PMD15/CN16/RD7            |
| C8         | OC5/PMWR/CN13/RD4         |
| C9         | VDD                       |
| C10        | SOSCI/CN1/RC13            |
| C11        | IC4/PMCS1/PMA14/RD11      |
| D1         | T2CK/RC1                  |
| D2         | PMD7/RE7                  |
| D3         | PMD5/RE5                  |
| D4         | Vss                       |
| D5         | Vss                       |
| D6         | No Connect (NC)           |
| D7         | PMD14/CN15/RD6            |
| D8         | CN19/PMD13/RD13           |
| D9         | SDO1/OC1/INT0/RD0         |
| D10        | No Connect (NC)           |
| D11        | SCK1/IC3/PMCS2/PMA15/RD10 |
| E1         | T5CK/SDI1/RC4             |
| E2         | T4CK/RC3                  |
| E3         | SCK2/PMA5/CN8/RG6         |
| E4         | T3CK/RC2                  |
| E5         | VDD                       |
| E6         | PMD9/RG1                  |
| E7         | Vss                       |

| Pin Number | Full Pin Name            |
|------------|--------------------------|
| E8         | SDA1/INT4/RA15           |
| E9         | RTCC/IC1/RD8             |
| E10        | SS1/IC2/RD9              |
| E11        | SCL1/INT3/RA14           |
| F1         | MCLR                     |
| F2         | SDO2/PMA3/CN10/RG8       |
| F3         | SS2/PMA2/CN11/RG9        |
| F4         | SDI2/PMA4/CN9/RG7        |
| F5         | Vss                      |
| F6         | No Connect (NC)          |
| F7         | No Connect (NC)          |
| F8         | VDD                      |
| F9         | OSC1/CLKI/RC12           |
| F10        | Vss                      |
| F11        | OSC2/CLKO/RC15           |
| G1         | INT1/RE8                 |
| G2         | INT2/RE9                 |
| G3         | TMS/RA0                  |
| G4         | No Connect (NC)          |
| G5         | VDD                      |
| G6         | Vss                      |
| G7         | Vss                      |
| G8         | No Connect (NC)          |
| G9         | TDO/RA5                  |
| G10        | SDA2/RA3                 |
| G11        | TDI/RA4                  |
| H1         | AN5/C1IN+/VBUSON/CN7/RB5 |
| H2         | AN4/C1IN-/CN6/RB4        |
| H3         | Vss                      |
| H4         | VDD                      |
| H5         | No Connect (NC)          |
| H6         | VDD                      |
| H7         | No Connect (NC)          |
| H8         | VBUS                     |
| H9         | VUSB                     |
| H10        | D+/RG2                   |
| H11        | SCL2/RA2                 |
| J1         | AN3/C2IN+/CN5/RB3        |
| J2         | AN2/C2IN-/CN4/RB2        |
| J3         | PGED2/AN7/RB7            |
| J4         | AVDD                     |
| J5         | AN11/PMA12/RB11          |
| J6         | TCK/RA1                  |
| J7         | AN12/PMA11/RB12          |
| J8         | No Connect (NC)          |
| J9         | No Connect (NC)          |
| J10        | U1TX/RF8                 |
| J11        | D-/RG3                   |
| K1         | PGEC1/AN1/CN3/RB1        |
| K2         | PGED1/AN0/CN2/RB0        |
| K3         | VREF+/CVREF+/PMA6/RA10   |

## 3.0 CPU

**Note 1:** This data sheet summarizes the features of the PIC32MX3XX/4XX family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 2. “CPU”** (DS61113) of the *“PIC32 Family Reference Manual”*, which is available from the Microchip web site ([www.microchip.com/PIC32](http://www.microchip.com/PIC32)). Resources for the MIPS32® M4K® Processor Core are available at: [www.mips.com/products/cores/32-64-bit-cores/mips32-m4k/](http://www.mips.com/products/cores/32-64-bit-cores/mips32-m4k/).

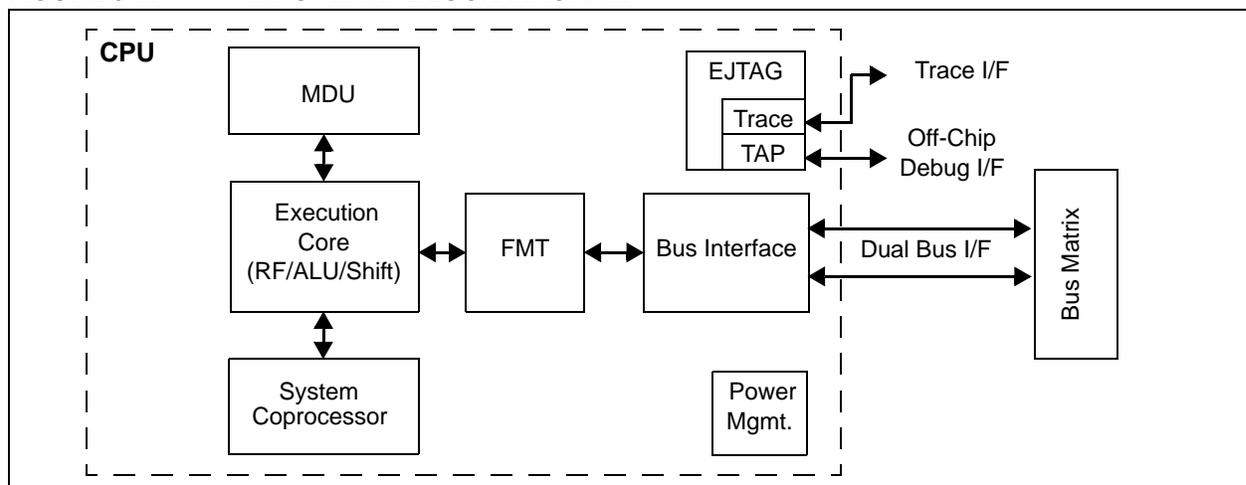
**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The MIPS32® M4K® Processor Core is the heart of the PIC32MX3XX/4XX family processor. The CPU fetches instructions, decodes each instruction, fetches source operands, executes each instruction and writes the results of instruction execution to the proper destinations.

### 3.1 Features

- 5-stage pipeline
- 32-bit Address and Data Paths
- MIPS32 Enhanced Architecture (Release 2)
  - Multiply-Accumulate and Multiply-Subtract Instructions
  - Targeted Multiply Instruction
  - Zero/One Detect Instructions
  - WAIT Instruction
  - Conditional Move Instructions (MOVN, MOVZ)
  - Vectored interrupts
  - Programmable exception vector base
- Atomic interrupt enable/disable
- GPR shadow registers to minimize latency for interrupt handlers
- Bit field manipulation instructions
- MIPS16e® Code Compression
  - 16-bit encoding of 32-bit instructions to improve code density
  - Special PC-relative instructions for efficient loading of addresses and constants
  - SAVE & RESTORE macro instructions for setting up and tearing down stack frames within subroutines
  - Improved support for handling 8 and 16-bit data types
- Simple Fixed Mapping Translation (FMT) mechanism
- Simple Dual Bus Interface
  - Independent 32-bit address and data busses
  - Transactions can be aborted to improve interrupt latency
- Autonomous Multiply/Divide Unit
  - Maximum issue rate of one 32x16 multiply per clock
  - Maximum issue rate of one 32x32 multiply every other clock
  - Early-in iterative divide. Minimum 11 and maximum 34 clock latency (dividend (rs) sign extension-dependent)
- Power Control
  - Minimum frequency: 0 MHz
  - Low-Power mode (triggered by WAIT instruction)
  - Extensive use of local gated clocks
- EJTAG Debug and Instruction Trace
  - Support for single stepping
  - Virtual instruction and data address/value breakpoints
  - PC tracing with trace compression

**FIGURE 3-1: MIPS® M4K® BLOCK DIAGRAM**



## 4.0 MEMORY ORGANIZATION

**Note 1:** This data sheet summarizes the features of the PIC32MX3XX/4XX family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 3. “Memory Organization”** (DS61115) of the *“PIC32 Family Reference Manual”*, which is available from the Microchip web site ([www.microchip.com/PIC32](http://www.microchip.com/PIC32)).

PIC32MX3XX/4XX microcontrollers provide 4 GB of unified virtual memory address space. All memory regions including program, data memory, SFRs and Configuration registers reside in this address space at their respective unique addresses. The program and data memories can be optionally partitioned into user and kernel memories. In addition, the data memory can be made executable, allowing PIC32MX3XX/4XX to execute from data memory.

## 4.1 Key Features

- 32-bit native data width
- Separate User and Kernel mode address space
- Flexible program Flash memory partitioning
- Flexible data RAM partitioning for data and program space
- Separate boot Flash memory for protected code
- Robust bus exception handling to intercept runaway code
- Simple memory mapping with Fixed Mapping Translation (FMT) unit
- Cacheable and non-cacheable address regions

## 4.2 PIC32MX3XX/4XX Memory Layout

PIC32MX3XX/4XX microcontrollers implement two address spaces: Virtual and Physical. All hardware resources such as program memory, data memory and peripherals are located at their respective physical addresses. Virtual addresses are exclusively used by the CPU to fetch and execute instructions as well as access peripherals. Physical addresses are used by peripherals such as DMA and Flash controller that access memory independently of CPU.

**TABLE 4-23: PORTC REGISTERS MAP FOR PIC32MX320F128L, PIC32MX340F128L, PIC32MX360F256L, PIC32MX360F512L, PIC32MX440F128L, PIC32MX460F256L AND PIC32MX460F512L DEVICES ONLY<sup>(1)</sup>**

| Virtual Address (BF88_#) | Register Name | Bit Range | Bits    |         |         |         |       |       |      |      |      |      |      |        |        |        |        | All Resets |       |
|--------------------------|---------------|-----------|---------|---------|---------|---------|-------|-------|------|------|------|------|------|--------|--------|--------|--------|------------|-------|
|                          |               |           | 31/15   | 30/14   | 29/13   | 28/12   | 27/11 | 26/10 | 25/9 | 24/8 | 23/7 | 22/6 | 21/5 | 20/4   | 19/3   | 18/2   | 17/1   |            | 16/0  |
| 6080                     | TRISC         | 31:16     | —       | —       | —       | —       | —     | —     | —    | —    | —    | —    | —    | —      | —      | —      | —      | —          | 0000  |
|                          |               | 15:0      | TRISC15 | TRISC14 | TRISC13 | TRISC12 | —     | —     | —    | —    | —    | —    | —    | TRISC4 | TRISC3 | TRISC2 | TRISC1 | —          | F01E  |
| 6090                     | PORTC         | 31:16     | —       | —       | —       | —       | —     | —     | —    | —    | —    | —    | —    | —      | —      | —      | —      | —          | 0000  |
|                          |               | 15:0      | RC15    | RC14    | RC13    | RC12    | —     | —     | —    | —    | —    | —    | —    | RC4    | RC3    | RC2    | RC1    | —          | xxxxx |
| 60A0                     | LATC          | 31:16     | —       | —       | —       | —       | —     | —     | —    | —    | —    | —    | —    | —      | —      | —      | —      | —          | 0000  |
|                          |               | 15:0      | LATC15  | LATC14  | LATC13  | LATC12  | —     | —     | —    | —    | —    | —    | —    | LATC4  | LATC3  | LATC2  | LATC1  | —          | xxxxx |
| 60B0                     | ODCC          | 31:16     | —       | —       | —       | —       | —     | —     | —    | —    | —    | —    | —    | —      | —      | —      | —      | —          | 0000  |
|                          |               | 15:0      | ODCC15  | ODCC14  | ODCC13  | ODCC12  | —     | —     | —    | —    | —    | —    | —    | ODCC4  | ODCC3  | ODCC2  | ODCC1  | —          | 0000  |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**Note 1:** All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See [Section 12.1.1 “CLR, SET and INV Registers”](#) for more information.

**TABLE 4-24: PORTC REGISTERS MAP FOR PIC32MX320F032H, PIC32MX320F064H, PIC32MX320F128H, PIC32MX340F128H, PIC32MX340F256H, PIC32MX340F512H, PIC32MX420F032H, PIC32MX440F128H, PIC32MX440F256H AND PIC32MX440F512H DEVICES ONLY<sup>(1)</sup>**

| Virtual Address (BF88_#) | Register Name | Bit Range | Bits    |         |         |         |       |       |      |      |      |      |      |      |      |      |      | All Resets |       |
|--------------------------|---------------|-----------|---------|---------|---------|---------|-------|-------|------|------|------|------|------|------|------|------|------|------------|-------|
|                          |               |           | 31/15   | 30/14   | 29/13   | 28/12   | 27/11 | 26/10 | 25/9 | 24/8 | 23/7 | 22/6 | 21/5 | 20/4 | 19/3 | 18/2 | 17/1 |            | 16/0  |
| 6080                     | TRISC         | 31:16     | —       | —       | —       | —       | —     | —     | —    | —    | —    | —    | —    | —    | —    | —    | —    | —          | 0000  |
|                          |               | 15:0      | TRISC15 | TRISC14 | TRISC13 | TRISC12 | —     | —     | —    | —    | —    | —    | —    | —    | —    | —    | —    | —          | F000  |
| 6090                     | PORTC         | 31:16     | —       | —       | —       | —       | —     | —     | —    | —    | —    | —    | —    | —    | —    | —    | —    | —          | 0000  |
|                          |               | 15:0      | RC15    | RC14    | RC13    | RC12    | —     | —     | —    | —    | —    | —    | —    | —    | —    | —    | —    | —          | xxxxx |
| 60A0                     | LATC          | 31:16     | —       | —       | —       | —       | —     | —     | —    | —    | —    | —    | —    | —    | —    | —    | —    | —          | 0000  |
|                          |               | 15:0      | LATC15  | LATC14  | LATC13  | LATC12  | —     | —     | —    | —    | —    | —    | —    | —    | —    | —    | —    | —          | xxxxx |
| 60B0                     | ODCC          | 31:16     | —       | —       | —       | —       | —     | —     | —    | —    | —    | —    | —    | —    | —    | —    | —    | —          | 0000  |
|                          |               | 15:0      | ODCC15  | ODCC14  | ODCC13  | ODCC12  | —     | —     | —    | —    | —    | —    | —    | —    | —    | —    | —    | —          | 0000  |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**Note 1:** All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See [Section 12.1.1 “CLR, SET and INV Registers”](#) for more information.

**TABLE 4-33: PORTG REGISTERS MAP FOR PIC32MX320F128L, PIC32MX340F128L, PIC32MX360F256L, PIC32MX360F512L, PIC32MX440F128L, PIC32MX460F256L AND PIC32MX460F512L DEVICES ONLY<sup>(1)</sup>**

| Virtual Address (BF88_#) | Register Name | Bit Range | Bits    |         |         |         |       |       |        |        |        |        |      |      |        |        |        | All Resets |       |
|--------------------------|---------------|-----------|---------|---------|---------|---------|-------|-------|--------|--------|--------|--------|------|------|--------|--------|--------|------------|-------|
|                          |               |           | 31/15   | 30/14   | 29/13   | 28/12   | 27/11 | 26/10 | 25/9   | 24/8   | 23/7   | 22/6   | 21/5 | 20/4 | 19/3   | 18/2   | 17/1   |            | 16/0  |
| 6180                     | TRISG         | 31:16     | —       | —       | —       | —       | —     | —     | —      | —      | —      | —      | —    | —    | —      | —      | —      | —          | 0000  |
|                          |               | 15:0      | TRISG15 | TRISG14 | TRISG13 | TRISG12 | —     | —     | TRISG9 | TRISG8 | TRISG7 | TRISG6 | —    | —    | TRISG3 | TRISG2 | TRISG1 | TRISG0     | F3CF  |
| 6190                     | PORTG         | 31:16     | —       | —       | —       | —       | —     | —     | —      | —      | —      | —      | —    | —    | —      | —      | —      | —          | 0000  |
|                          |               | 15:0      | RG15    | RG14    | RG13    | RG12    | —     | —     | RG9    | RG8    | RG7    | RG6    | —    | —    | RG3    | RG2    | RG1    | RG0        | xxxxx |
| 61A0                     | LATG          | 31:16     | —       | —       | —       | —       | —     | —     | —      | —      | —      | —      | —    | —    | —      | —      | —      | —          | 0000  |
|                          |               | 15:0      | LATG15  | LATG14  | LATG13  | LATG12  | —     | —     | LATG9  | LATG8  | LATG7  | LATG6  | —    | —    | LATG3  | LATG2  | LATG1  | LATG0      | xxxxx |
| 61B0                     | ODCG          | 31:16     | —       | —       | —       | —       | —     | —     | —      | —      | —      | —      | —    | —    | —      | —      | —      | —          | 0000  |
|                          |               | 15:0      | ODCG15  | ODCG14  | ODCG13  | ODCG12  | —     | —     | ODCG9  | ODCG8  | ODCG7  | ODCG6  | —    | —    | ODCG3  | ODCG2  | ODCG1  | ODCG0      | 0000  |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**Note 1:** All registers in this table have corresponding CLR, SET, and INV registers at their virtual addresses, plus offsets of 0x4, 0x8, and 0xC, respectively. See [Section 12.1.1 “CLR, SET and INV Registers”](#) for more information.

**TABLE 4-34: PORTG REGISTERS MAP FOR PIC32MX320F032H, PIC32MX320F064H, PIC32MX320F128H, PIC32MX340F128H, PIC32MX340F256H, PIC32MX340F512H, PIC32MX420F032H, PIC32MX440F128H, PIC32MX440F256H AND PIC32MX440F512H DEVICES ONLY<sup>(1)</sup>**

| Virtual Address (BF88_#) | Register Name | Bit Range | Bits  |       |       |       |       |       |        |        |        |        |      |      |        |        |      | All Resets |       |
|--------------------------|---------------|-----------|-------|-------|-------|-------|-------|-------|--------|--------|--------|--------|------|------|--------|--------|------|------------|-------|
|                          |               |           | 31/15 | 30/14 | 29/13 | 28/12 | 27/11 | 26/10 | 25/9   | 24/8   | 23/7   | 22/6   | 21/5 | 20/4 | 19/3   | 18/2   | 17/1 |            | 16/0  |
| 6180                     | TRISG         | 31:16     | —     | —     | —     | —     | —     | —     | —      | —      | —      | —      | —    | —    | —      | —      | —    | —          | 0000  |
|                          |               | 15:0      | —     | —     | —     | —     | —     | —     | TRISG9 | TRISG8 | TRISG7 | TRISG6 | —    | —    | TRISG3 | TRISG2 | —    | —          | 03cc  |
| 6190                     | PORTG         | 31:16     | —     | —     | —     | —     | —     | —     | —      | —      | —      | —      | —    | —    | —      | —      | —    | —          | 0000  |
|                          |               | 15:0      | —     | —     | —     | —     | —     | —     | RG9    | RG8    | RG7    | RG6    | —    | —    | RG3    | RG2    | —    | —          | xxxxx |
| 61A0                     | LATG          | 31:16     | —     | —     | —     | —     | —     | —     | —      | —      | —      | —      | —    | —    | —      | —      | —    | —          | 0000  |
|                          |               | 15:0      | —     | —     | —     | —     | —     | —     | LATG9  | LATG8  | LATG7  | LATG6  | —    | —    | LATG3  | LATG2  | —    | —          | xxxxx |
| 61B0                     | ODCG          | 31:16     | —     | —     | —     | —     | —     | —     | —      | —      | —      | —      | —    | —    | —      | —      | —    | —          | 0000  |
|                          |               | 15:0      | —     | —     | —     | —     | —     | —     | ODCG9  | ODCG8  | ODCG7  | ODCG6  | —    | —    | ODCG3  | ODCG2  | —    | —          | 0000  |

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**Note 1:** All registers in this table have corresponding CLR, SET and INV registers at their virtual addresses, plus offsets of 0x4, 0x8 and 0xC, respectively. See [Section 12.1.1 “CLR, SET and INV Registers”](#) for more information.

## 22.0 10-BIT ANALOG-TO-DIGITAL CONVERTER (ADC)

**Note 1:** This data sheet summarizes the features of the PIC32MX3XX/4XX family of devices. It is not intended to be a comprehensive reference source. Refer to **Section 17. “10-bit Analog-to-Digital Converter (ADC)”** (DS61104) of the “PIC32 Family Reference Manual”, which is available from the Microchip web site ([www.microchip.com/PIC32](http://www.microchip.com/PIC32)).

**2:** Some registers and associated bits described in this section may not be available on all devices. Refer to **Section 4.0 “Memory Organization”** in this data sheet for device-specific register and bit information.

The PIC32MX3XX/4XX 10-bit Analog-to-Digital Converter (ADC) includes the following features:

- Successive Approximation Register (SAR) conversion
- Up to 1000 kilo samples per second (ksp/s) conversion speed
- Up to 16 analog input pins
- External voltage reference input pins
- One unipolar, differential Sample-and-Hold Amplifier (SHA)

- Automatic Channel Scan mode
- Selectable conversion trigger source
- 16-word conversion result buffer
- Selectable Buffer Fill modes
- Eight conversion result format options
- Operation during CPU Sleep and Idle modes

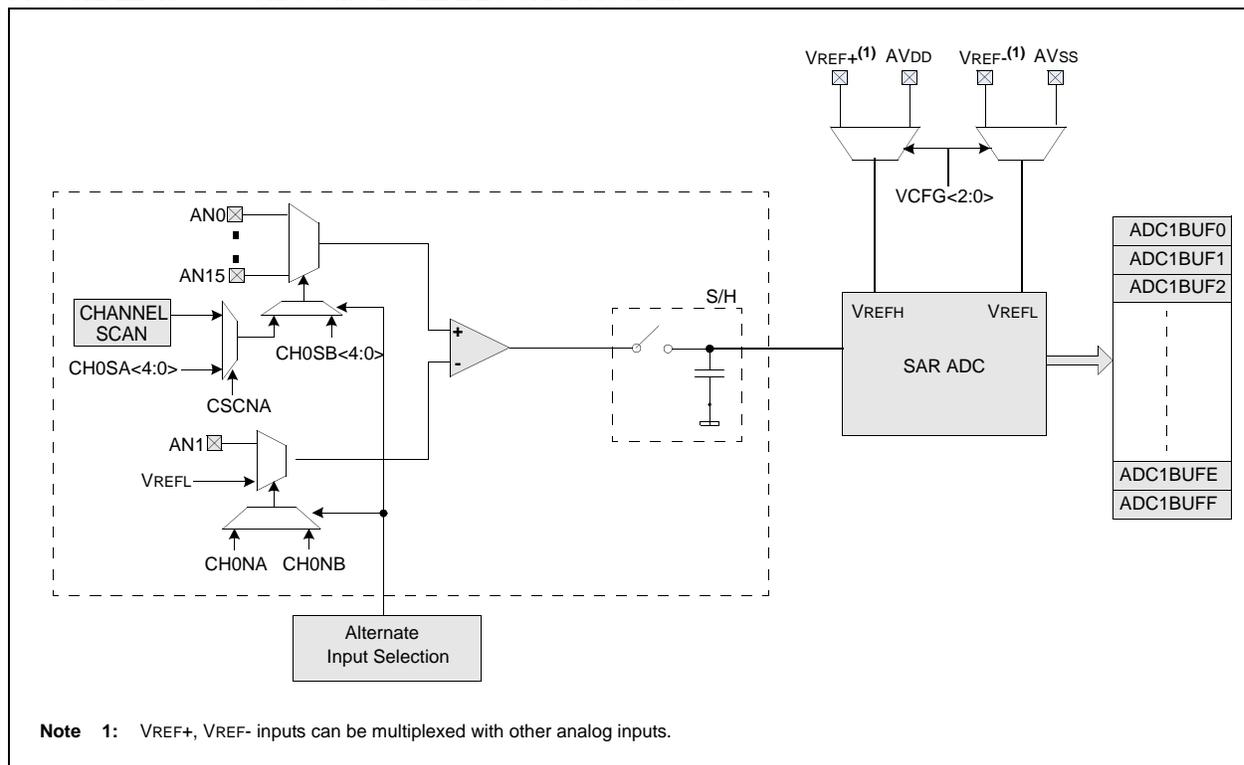
A block diagram of the 10-bit ADC is illustrated in **Figure 22-1**. The 10-bit ADC has 16 analog input pins, designated AN0-AN15. In addition, there are two analog input pins for external voltage reference connections. These voltage reference inputs may be shared with other analog input pins and may be common to other analog module references.

The analog inputs are connected through two multiplexers (MUXs) to one SHA. The analog input MUXs can be switched between two sets of analog inputs between conversions. Unipolar differential conversions are possible on all channels, other than the pin used as the reference, using a reference input pin (see **Figure 22-1**).

The Analog Input Scan mode sequentially converts user-specified channels. A control register specifies which analog input channels will be included in the scanning sequence.

The 10-bit ADC is connected to a 16-word result buffer. Each 10-bit result is converted to one of eight, 32-bit output formats when it is read from the result buffer.

**FIGURE 22-1: ADC1 MODULE BLOCK DIAGRAM**



## 29.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of PIC32MX3XX/4XX electrical characteristics. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC32MX3XX/4XX are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these or any other conditions above the parameters indicated in the operation listings of this specification is not implied.

### Absolute Maximum Ratings

#### (Note 1)

|   |                       |
|---|-----------------------|
| Ambient temperature under bias.....   | -40°C to +105°C       |
| Storage temperature .....   | -65°C to +150°C       |
| Voltage on VDD with respect to VSS .....  | -0.3V to +4.0V        |
| Voltage on any pin that is not 5V tolerant, with respect to VSS ( <b>Note 3</b> ).....    | -0.3V to (VDD + 0.3V) |
| Voltage on any 5V tolerant pin with respect to VSS when VDD ≥ 2.3V ( <b>Note 3</b> )..... | -0.3V to +5.5V        |
| Voltage on any 5V tolerant pin with respect to VSS when VDD < 2.3V ( <b>Note 3</b> )..... | -0.3V to +3.6V        |
| Voltage on VCORE with respect to VSS .....  | -0.3V to 2.0V         |
| Voltage on VBUS with respect to VSS .....   | -0.3V to +5.5V        |
| Maximum current out of VSS pin(s).....  | 300 mA                |
| Maximum current into VDD pin(s) ( <b>Note 2</b> ).....                                    | 300 mA                |
| Maximum output current sunk by any I/O pin.....   | 25 mA                 |
| Maximum output current sourced by any I/O pin .....                                       | 25 mA                 |
| Maximum current sunk by all ports .....   | 200 mA                |
| Maximum current sourced by all ports ( <b>Note 2</b> ).....                               | 200 mA                |

**Note 1:** Stresses above those listed under “**Absolute Maximum Ratings**” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

**2:** Maximum allowable current is a function of device maximum power dissipation (see [Table 29-2](#)).

**3:** See the “[Pin Diagrams](#)” section for the 5V tolerant pins.

**TABLE 29-8: DC CHARACTERISTICS: I/O PIN INPUT SPECIFICATIONS**

| DC CHARACTERISTICS |        |                              | Standard Operating Conditions: 2.3V to 3.6V (unless otherwise stated)                 |                        |          |       |   |
|--------------------|--------|------------------------------|---|------------------------|----------|-------|---|
|                    |        |                              | Operating temperature -40°C ≤TA ≤+85°C for Industrial<br>-40°C ≤TA ≤+105°C for V-Temp |                        |          |       |   |
| Param. No.         | Symbol | Characteristics              | Min.  | Typical <sup>(1)</sup> | Max.     | Units | Conditions                                    |
| DI10               | VIL    | <b>Input Low Voltage</b>     |   |                        |          |       |   |
|                    |        | I/O pins:                    |   |                        |          |       |   |
|                    |        | with TTL Buffer              | VSS   | —                      | 0.15 VDD | V     | (Note 4)                                      |
|                    |        | with Schmitt Trigger Buffer  | VSS   | —                      | 0.2 VDD  | V     | (Note 4)                                      |
|                    |        | <u>MCLR</u>                  | VSS   | —                      | 0.2 VDD  | V     | (Note 4)                                      |
|                    |        | OSC1 (XT mode)               | VSS   | —                      | 0.2 VDD  | V     | (Note 4)                                      |
|                    |        | OSC1 (HS mode)               | VSS   | —                      | 0.2 VDD  | V     | (Note 4)                                      |
| DI15               |        | <u>MCLR</u>                  | VSS   | —                      | 0.2 VDD  | V     | (Note 4)                                      |
| DI16               |        | OSC1 (XT mode)               | VSS   | —                      | 0.2 VDD  | V     | (Note 4)                                      |
| DI17               |        | OSC1 (HS mode)               | VSS   | —                      | 0.2 VDD  | V     | (Note 4)                                      |
| DI18               |        | SDAx, SCLx                   | VSS   | —                      | 0.3 VDD  | V     | SMBus disabled<br>(Note 4)                    |
| DI19               |        | SDAx, SCLx                   | VSS   | —                      | 0.8      | V     | SMBus enabled<br>(Note 4)                     |
| DI20               | VIH    | <b>Input High Voltage</b>    |   |                        |          |       |   |
|                    |        | I/O pins:                    |   |                        |          |       |   |
|                    |        | with Analog Functions        | 0.8 VDD   | —                      | VDD      | V     | (Note 4)                                      |
|                    |        | Digital Only                 | 0.8 VDD   | —                      |          | V     | (Note 4)                                      |
|                    |        | with TTL Buffer              | 0.25VDD + 0.8V  | —                      | 5.5      | V     | (Note 4)                                      |
|                    |        | with Schmitt Trigger Buffer  | 0.8 VDD   | —                      | 5.5      | V     | (Note 4)                                      |
|                    |        | <u>MCLR</u>                  | 0.8 VDD   | —                      | VDD      | V     | (Note 4)                                      |
|                    |        | OSC1 (XT mode)               | 0.7 VDD   | —                      | VDD      | V     | (Note 4)                                      |
|                    |        | OSC1 (HS mode)               | 0.7 VDD   | —                      | VDD      | V     | (Note 4)                                      |
|                    |        | SDAx, SCLx                   | 0.7 VDD   | —                      | 5.5      | V     | SMBus disabled<br>(Note 4)                    |
| DI25               |        | <u>MCLR</u>                  | 0.8 VDD   | —                      | VDD      | V     | (Note 4)                                      |
| DI26               |        | OSC1 (XT mode)               | 0.7 VDD   | —                      | VDD      | V     | (Note 4)                                      |
| DI27               |        | OSC1 (HS mode)               | 0.7 VDD   | —                      | VDD      | V     | (Note 4)                                      |
| DI28               |        | SDAx, SCLx                   | 0.7 VDD   | —                      | 5.5      | V     | SMBus disabled<br>(Note 4)                    |
| DI29               |        | SDAx, SCLx                   | 2.1   | —                      | 5.5      | V     | SMBus enabled,<br>2.3V ≤VPIN ≤5.5<br>(Note 4) |
| DI30               | ICNPU  | <b>CNxx Pull up Current</b>  | 50  | 250                    | 400      | μA    | VDD = 3.3V, VPIN = VSS                        |
| DI50               | IIL    | <b>Input Leakage Current</b> |   |                        |          |       | (Note 3)                                      |
|                    |        | I/O Ports                    | —   | —                      | ±1       | μA    | VSS ≤VPIN ≤VDD,<br>Pin at high-impedance      |
|                    |        | Analog Input Pins            | —   | —                      | ±1       | μA    | VSS ≤VPIN ≤VDD,<br>Pin at high-impedance      |
|                    |        | <u>MCLR</u>                  | —   | —                      | ±1       | μA    | VSS ≤VPIN ≤VDD                                |
|                    |        | OSC1                         | —   | —                      | ±1       | μA    | VSS ≤VPIN ≤VDD,<br>XT and HS modes            |

- Note 1:** Data in "Typical" column is at 3.3V, 25°C unless otherwise stated. Parameters are for design guidance only and are not tested.
- 2:** The leakage current on the MCLR pin is strongly dependent on the applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3:** Negative current is defined as current sourced by the pin.
- 4:** This parameter is characterized, but not tested in manufacturing.

**TABLE 29-11: DC CHARACTERISTICS: PROGRAM MEMORY<sup>(3)</sup>**

| DC CHARACTERISTICS          |                        |  | Standard Operating Conditions: 2.3V to 3.6V<br>(unless otherwise stated)<br>Operating temperature -40°C ≤TA ≤+85°C for Industrial<br>-40°C ≤TA ≤+105°C for V-Temp |                        |      |       |            |
|-----------------------------|------------------------|--|---|------------------------|------|-------|------------|
| Param. No.                  | Symbol                 | Characteristics  | Min.  | Typical <sup>(1)</sup> | Max. | Units | Conditions |
| <b>Program Flash Memory</b> |                        |  |   |                        |      |       |            |
| D130                        | EP                     | Cell Endurance   | 1000  | —                      | —    | E/W   | —          |
| D131                        | VPR                    | VDD for Read   | V <sub>MIN</sub>  | —                      | 3.6  | V     | —          |
| D132                        | VPEW                   | VDD for Erase or Write                                     | 3.0   | —                      | 3.6  | V     | —          |
| D134                        | TRETD                  | Characteristic Retention                                   | 20  | —                      | —    | Year  | —          |
| D135                        | IDDP                   | Supply Current during Programming                          | —   | 10                     | —    | mA    | —          |
|                             | T <sub>WW</sub>        | Word Write Cycle Time                                      | 20  | —                      | 40   | μs    | —          |
| D136                        | T <sub>RW</sub>        | Row Write Cycle Time <sup>(2)</sup><br>(128 words per row) | 3   | 4.5                    | —    | ms    | —          |
| D137                        | T <sub>PE</sub>        | Page Erase Cycle Time                                      | 20  | —                      | —    | ms    | —          |
|                             | T <sub>CE</sub>        | Chip Erase Cycle Time                                      | 80  | —                      | —    | ms    | —          |
| D138                        | LVD <sub>startup</sub> | Flash LVD Delay  | —   | —                      | 6    | μs    | —          |

**Note 1:** Data in “Typical” column is at 3.3V, 25°C unless otherwise stated.

**2:** The minimum SYSCLK for row programming is 4 MHz. Care should be taken to minimize bus activities during row programming, such as suspending any memory-to-memory DMA operations. If heavy bus loads are expected, selecting Bus Matrix Arbitration mode 2 (rotating priority) may be necessary. The default Arbitration mode is mode 1 (CPU has lowest priority).

**3:** Refer to the “PIC32MX Flash Programming Specification” (DS61145) for operating conditions during programming and erase cycles.

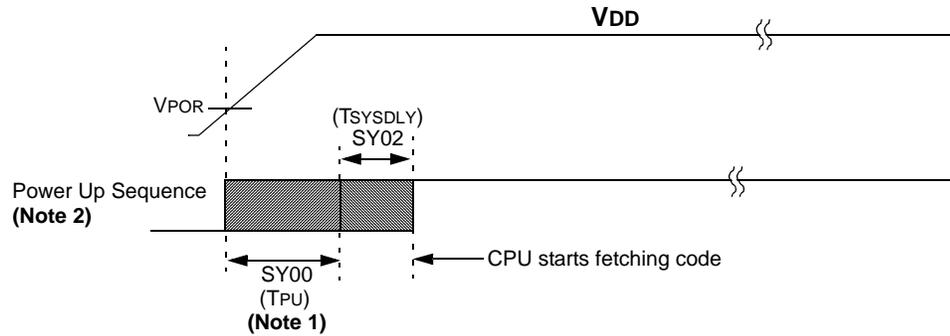
**TABLE 29-12: PROGRAM FLASH MEMORY WAIT STATE CHARACTERISTICS**

| DC CHARACTERISTICS         |          | Standard Operating Conditions: 2.3V to 3.6V<br>(unless otherwise stated)<br>Operating temperature -40°C ≤TA ≤+85°C for Industrial<br>-40°C ≤TA ≤+105°C for V-Temp |          |  |
|----------------------------|----------|---|----------|--|
| Required Flash wait states | SYSCLK   | Units   | Comments |  |
| 0 Wait State               | 0 to 30  | MHz   | —        |  |
| 1 Wait State               | 31 to 60 |   |          |  |
| 2 Wait States              | 61 to 80 |   |          |  |

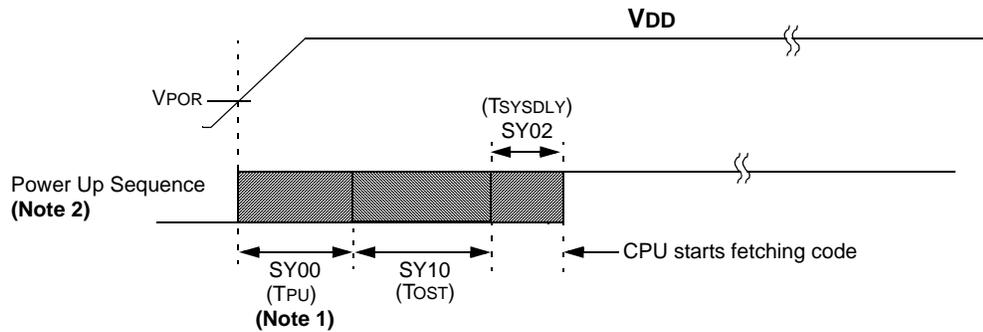
**Note 1:** 40 MHz maximum for PIC32MX320F032H and PIC32MX420F032H devices.

**FIGURE 29-4: POWER-ON RESET TIMING CHARACTERISTICS**

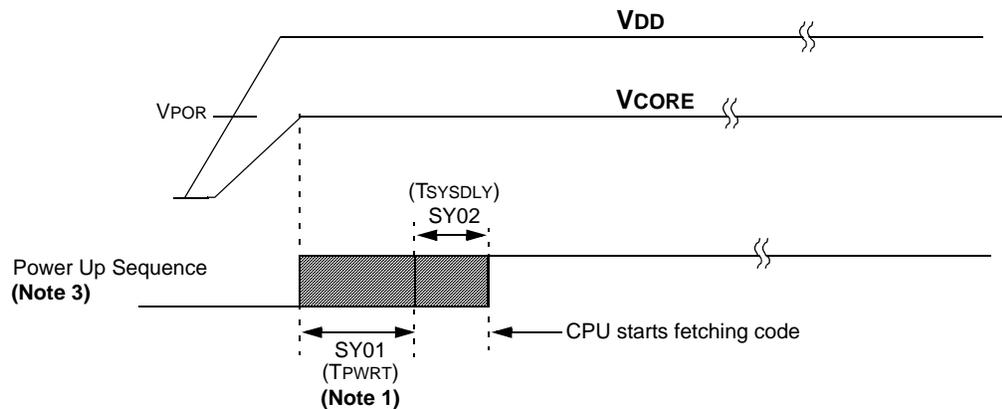
**Internal Voltage Regulator Enabled**  
**Clock Sources = (FRC, FRCDIV, FRCDIV16, FRCPLL, EC, ECPLL and LPRC)**



**Internal Voltage Regulator Enabled**  
**Clock Sources = (HS, HSPLL, XT, XTPLL and Sosc)**



**External V<sub>CORE</sub> Provided**  
**Clock Sources = (FRC, FRCDIV, FRCDIV16, FRCPLL, EC, ECPLL and LPRC)**



- Note 1:** The Power-up period will be extended if the power-up sequence completes before the device exits from BOR ( $V_{DD} < V_{DDMIN}$ ).
- 2:** Includes interval voltage regulator stabilization delay.
- 3:** Power-up Timer (PWRT); only active when the internal voltage regulator is disabled.

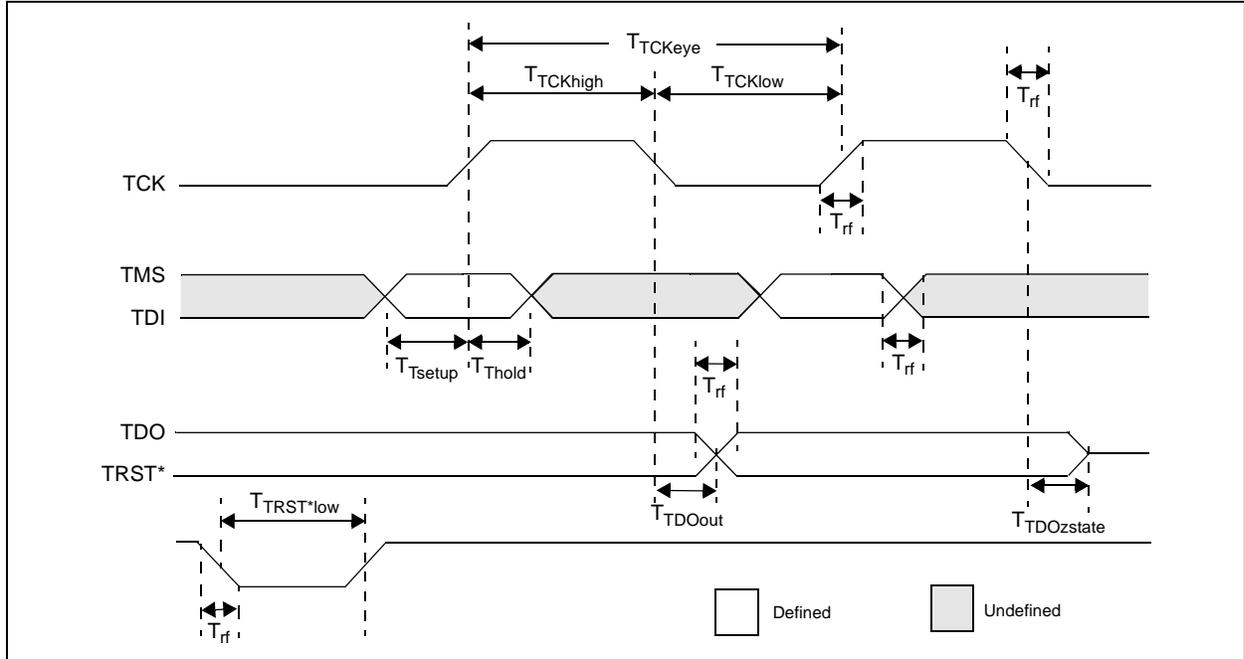
# PIC32MX3XX/4XX

**TABLE 29-40: OTG ELECTRICAL SPECIFICATIONS**

| AC CHARACTERISTICS |        |                                   | Standard Operating Conditions: 2.3V to 3.6V<br>(unless otherwise stated)<br>Operating temperature -40°C ≤TA ≤+85°C for Industrial<br>-40°C ≤TA ≤+105°C for V-Temp |     |      |       |   |
|--------------------|--------|-----------------------------------|---|-----|------|-------|---|
| Param. No.         | Symbol | Characteristics <sup>(1)</sup>    | Min.  | Typ | Max. | Units | Conditions  |
| USB313             | VUSB   | USB Voltage                       | 3.0   | —   | 3.6  | V     | Voltage on VUSB must be in this range for proper USB operation.           |
| USB315             | VILUSB | Input Low Voltage for USB Buffer  | —   | —   | 0.8  | V     | —   |
| USB316             | VIHUSB | Input High Voltage for USB Buffer | 2.0   | —   | —    | V     | —   |
| USB318             | VDIFS  | Differential Input Sensitivity    | —   | —   | 0.2  | V     | The difference between D+ and D- must exceed this value while VCM is met. |
| USB319             | VCM    | Differential Common Mode Range    | 0.8   | —   | 2.5  | V     | —   |
| USB320             | ZOUT   | Driver Output Impedance           | 28.0  | —   | 44.0 | Ω     | —   |
| USB321             | VOL    | Voltage Output Low                | 0.0   | —   | 0.3  | V     | 1.5 kΩ load connected to 3.6V.  |
| USB322             | VOH    | Voltage Output High               | 2.8   | —   | 3.6  | V     | 1.5 kΩ load connected to ground.  |

**Note 1:** These parameters are characterized, but not tested in manufacturing.

**FIGURE 29-23: EJTAG TIMING CHARACTERISTICS**



**TABLE 29-41: EJTAG TIMING REQUIREMENTS**

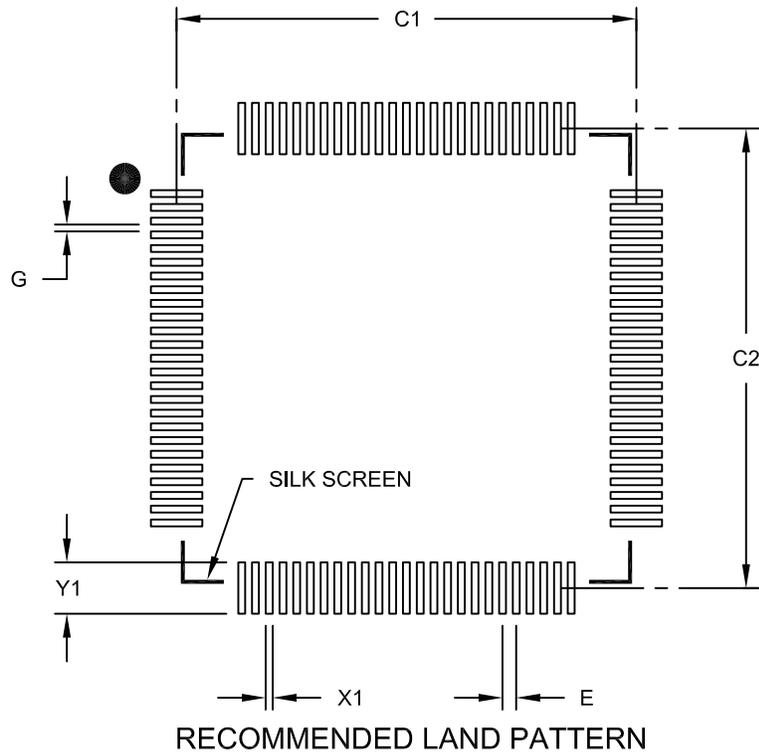
| AC CHARACTERISTICS |            |  | Standard Operating Conditions: 2.3V to 3.6V<br>(unless otherwise stated)<br>Operating temperature -40°C ≤ TA ≤ +85°C for Industrial<br>-40°C ≤ TA ≤ +105°C for V-Temp |      |       |            |
|--------------------|------------|--|---|------|-------|------------|
| Param. No.         | Symbol     | Description <sup>(1)</sup>                       | Min.  | Max. | Units | Conditions |
| EJ1                | TTCKCYC    | TCK Cycle Time                                   | 25  | —    | ns    | —          |
| EJ2                | TTCKHIGH   | TCK High Time                                    | 10  | —    | ns    | —          |
| EJ3                | TTCKLOW    | TCK Low Time                                     | 10  | —    | ns    | —          |
| EJ4                | TTSETUP    | TAP Signals Setup Time Before Rising TCK         | 5   | —    | ns    | —          |
| EJ5                | TTHOLD     | TAP Signals Hold Time After Rising TCK           | 3   | —    | ns    | —          |
| EJ6                | TTDOOUT    | TDO Output Delay Time from Falling TCK           | —   | 5    | ns    | —          |
| EJ7                | TTDOZSTATE | TDO 3-State Delay Time from Falling TCK          | —   | 5    | ns    | —          |
| EJ8                | TTRSTLOW   | TRST Low Time                                    | 25  | —    | ns    | —          |
| EJ9                | TRF        | TAP Signals Rise/Fall Time, All Input and Output | —   | —    | ns    | —          |

**Note 1:** These parameters are characterized, but not tested in manufacturing.

# PIC32MX3XX/4XX

100-Lead Plastic Thin Quad Flatpack (PT)-12x12x1mm Body, 2.00 mm Footprint [TQFP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits          | Units | MILLIMETERS |       |      |
|---------------------------|-------|-------------|-------|------|
|                           |       | MIN         | NOM   | MAX  |
| Contact Pitch             | E     | 0,40 BSC    |       |      |
| Contact Pad Spacing       | C1    |             | 13,40 |      |
| Contact Pad Spacing       | C2    |             | 13,40 |      |
| Contact Pad Width (X100)  | X1    |             |       | 0,20 |
| Contact Pad Length (X100) | Y1    |             |       | 1,50 |
| Distance Between Pads     | G     | 0,20        |       |      |

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M  
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2100B

# PIC32MX3XX/4XX

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NOTES:

# PIC32MX3XX/4XX

TABLE A-1: MAJOR SECTION UPDATES (CONTINUED)

| Section Name                                     | Update Description  |
|--|---|
| <b>Section 26.0 “Special Features”</b>           | <p>Modified bit names and locations in <b>Register 26-5 “DEVID: Device and Revision ID Register”</b>.</p> <p>Replaced “TSTARTUP” with “TPU”, and “64-ms nominal delay” with “TPWRT”, in <b>Section 26.3.1 “On-Chip Regulator and POR”</b>.</p> <p>The information that appeared in the Watchdog Timer and the Programming and Diagnostics sections of 61143E version of this data sheet has been incorporated into the Special Features section:</p> <ul style="list-style-type: none"><li>• <b>Section 26.2 “Watchdog Timer (WDT)”</b></li><li>• <b>Section 26.4 “Programming and Diagnostics”</b></li></ul> |
| <b>Section 29.0 “Electrical Characteristics”</b> | <p>Added the 64-Lead QFN package to Table 29-3.</p> <p>Updated data in Table 29-5.</p> <p>Updated data in Table 29-7.</p> <p>Updated data in Table 29-4, Table 29-5, Table 29-7 and Table 29-8.</p> <p>Updated data in Table 29-11.</p> <p>Added OS42 parameter to Table 29-17.</p> <p>Replaced Table 29-23.</p> <p>Replaced Table 29-24.</p> <p>Replaced Table 29-25.</p> <p>Updated Table 29-36.</p>  |
| <b>Section 30.0 “Packaging Information”</b>      | <p>Added 64-Lead QFN package marking information to <b>Section 30.1 “Package Marking Information”</b>.</p> <p>Added the 64-Lead QFN (MR) package drawing and land pattern to <b>Section 30.2 “Package Details”</b>.</p>   |
| <b>“Product Identification System”</b>           | <p>Added the MR package designator for the 64-Lead (9x9x0.9) QFN.</p>   |



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